

N-channel TrenchMOS standard level FET

Rev. 02 — 31 July 2009

**Product data sheet** 

### 1. Product profile

#### **1.1 General description**

Standard level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

#### 1.2 Features and benefits

- Low conduction losses due to low on-state resistance
- Q101 compliant

- Suitable for standard level gate drive sources
- Suitable for thermally demanding environments due to 175 °C rating

Motors, lamps and solenoids

#### **1.3 Applications**

- 12 V, 24 V and 42 V loads
- Automotive and general purpose power switching

#### 1.4 Quick reference data

#### Table 1. Quick reference

Table 1.	Quick reference					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	-	100	V
I <sub>D</sub>	drain current	$V_{GS} = 10 \text{ V}; T_{mb} = 25 \text{ °C};$ see <u>Figure 1</u> and <u>3</u>	-	-	23	A
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	-	99	W
Avalanc	he ruggedness					
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$ \begin{split} I_D &= 14 \text{ A}; \ V_{sup} \leq 100 \text{ V}; \\ R_{GS} &= 50 \ \Omega; \ V_{GS} = 10 \text{ V}; \\ T_{j(init)} &= 25 \ ^\circ\text{C}; \ unclamped \end{split} $	-	-	100	mJ
Static ch	aracteristics					
R <sub>DSon</sub>	drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 13 \text{ A};$ $T_j = 175 \text{ °C}; \text{ see } Figure 12$ and <u>13</u>	-	-	187	mΩ
		$V_{GS} = 10 \text{ V}; I_D = 13 \text{ A};$ $T_j = 25 \text{ °C}; \text{ see } Figure 12$ and <u>13</u>	-	64	75	mΩ

# nexperia

## 2. Pinning information

Table 2.	Pinning	information				
Pin	Symbol	Description	Simplified outline	Graphic symbol		
1	G	gate		_		
2	D	drain	mb			
3	S	source				
mb	D	mounting base; connected to drain	SOT404	mbb076 S		
			(D2PAK)			

# 3. Ordering information

# Table 3. Ordering information Type number Package Name Description Version BUK7675-100A D2PAK plastic single-ended surface-mounted package (D2PAK); 3 leads (one lead cropped) SOT404

## 4. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage	T <sub>j</sub> ≥ 25 °C; T <sub>j</sub> ≤ 175 °C	-	100	V
V <sub>DGR</sub>	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	100	V
V <sub>GS</sub>	gate-source voltage		-20	20	V
I <sub>D</sub>	drain current	$T_{mb}$ = 25 °C; $V_{GS}$ = 10 V; see <u>Figure 1</u> and <u>3</u>	-	23	А
		$T_{mb}$ = 100 °C; $V_{GS}$ = 10 V; see <u>Figure 1</u>	-	16.2	А
I <sub>DM</sub>	peak drain current	$T_{mb} = 25 \text{ °C}; t_p \le 10  \mu\text{s}; \text{ pulsed}; \text{ see } \frac{\text{Figure 3}}{10  \mu\text{s}}$	-	92	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; see <u>Figure 2</u>	-	99	W
T <sub>stg</sub>	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Avalanche	e ruggedness				
E <sub>DS(AL)S</sub>	non-repetitive drain-source avalanche energy	$    I_D = 14 \text{ A};  \text{V}_{sup} \leq 100 \text{ V};  \text{R}_{GS} = 50  \Omega;  \text{V}_{GS} = 10 \text{ V}; \\     T_{j(\text{init})} = 25 ^{\circ}\text{C}; \text{ unclamped} $	-	100	mJ
Source-dr	rain diode				
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C	-	23	А
I <sub>SM</sub>	peak source current	t <sub>p</sub> ≤ 10 μs; pulsed; T <sub>mb</sub> = 25 °C	-	92	А

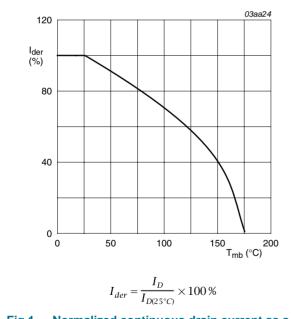
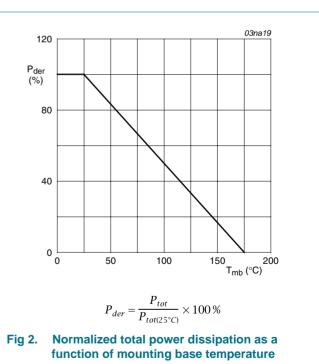
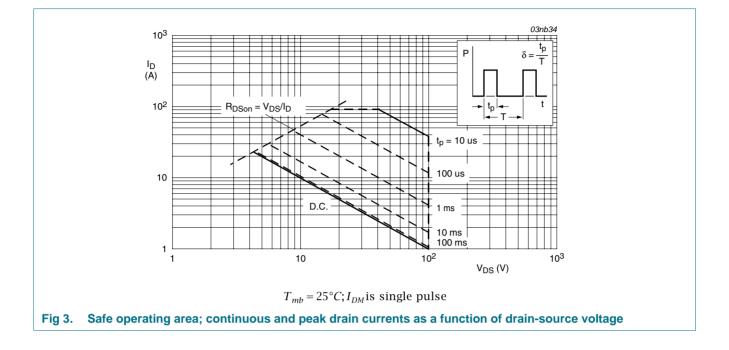


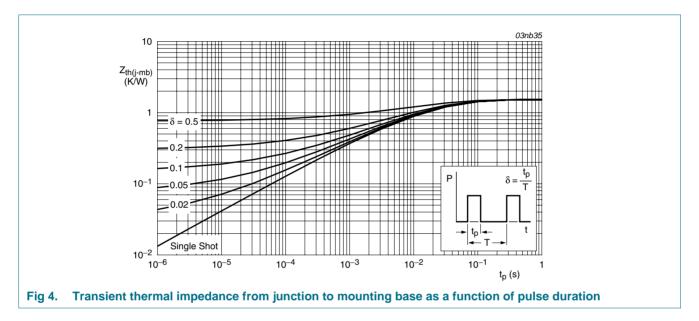
Fig 1. Normalized continuous drain current as a function of mounting base temperature





## 5. Thermal characteristics

Table 5.	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	see <u>Figure 4</u>		-	-	1.5	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient			-	50	-	K/W

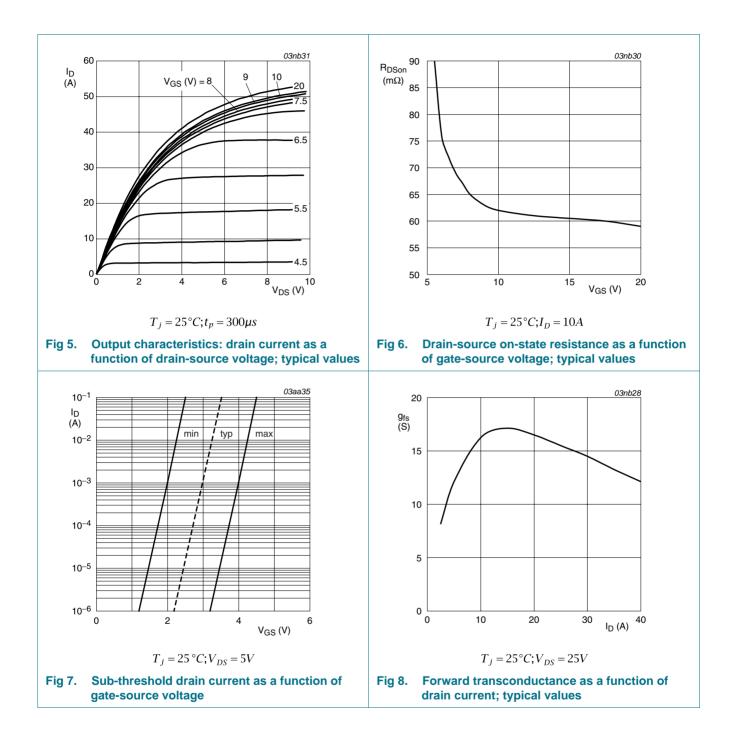


# 6. Characteristics

Table 6.	Characteristics							
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
Static characteristics								
V <sub>(BR)DSS</sub>	drain-source	$I_D = 0.25 \text{ A};  V_{GS} = 0  \text{V};  T_j = 25 ^\circ\text{C}$	100	-	-	V		
	breakdown voltage	$I_D = 0.25 \text{ A}; V_{GS} = 0 \text{ V}; T_j = -55 \text{ °C}$	89	-	-	V		
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 11</u>	1	-	-	V		
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u>	-	-	4.4	V		
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u>	2	3	4	V		
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 100 V; $V_{GS}$ = 0 V; $T_j$ = 175 °C	-	-	500	μΑ		
		$V_{DS}$ = 100 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	0.05	10	μA		
I <sub>GSS</sub>	gate leakage current	$V_{DS} = 0 \text{ V}; V_{GS} = 20 \text{ V}; T_j = 25 \text{ °C}$	-	2	100	nA		
		$V_{DS} = 0 \text{ V}; \text{ V}_{GS} = -20 \text{ V}; \text{ T}_{j} = 25 \text{ °C}$	-	2	100	nA		
R <sub>DSon</sub>	drain-source on-state resistance	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 13 A; T <sub>j</sub> = 175 °C; see <u>Figure 12</u> and <u>13</u>	-	-	187	mΩ		
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 13 A; T <sub>j</sub> = 25 °C; see <u>Figure 12</u> and <u>13</u>	-	64	75	mΩ		
Dynamic	characteristics							
C <sub>iss</sub>	input capacitance	$V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz;$	-	907	1210	pF		
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; see <u>Figure 15</u>	-	127	150	pF		
C <sub>rss</sub>	reverse transfer capacitance		-	78	110	pF		
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 30 V; $R_L$ = 2.2 $\Omega$ ; $V_{GS}$ = 10 V;	-	8	-	ns		
t <sub>r</sub>	rise time	$R_{G(ext)} = 5.6 \Omega; T_j = 25 \text{ °C}$	-	39	-	ns		
t <sub>d(off)</sub>	turn-off delay time		-	26	-	ns		
t <sub>f</sub>	fall time		-	24	-	ns		
L <sub>D</sub>	internal drain inductance	from drain lead 6 mm from package to centre of die; $T_j = 25 \text{ °C}$	-	4.5	-	nH		
		from upper edge of drain mounting base to centre of die; $T_j = 25 \text{ °C}$	-	2.5	-	nH		
L <sub>S</sub>	internal source inductance	from source lead to source bond pad; $T_j = 25 \text{ °C}$	-	7.5	-	nH		
Source-d	rain diode							
$V_{SD}$	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; see <u>Figure 14</u>	-	0.85	1.2	V		
t <sub>rr</sub>	reverse recovery time	$I_{S} = 13 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = -10 \text{ V};$	-	64	-	ns		
Qr	recovered charge	V <sub>DS</sub> = 30 V; T <sub>j</sub> = 25 °C	-	120	-	nC		

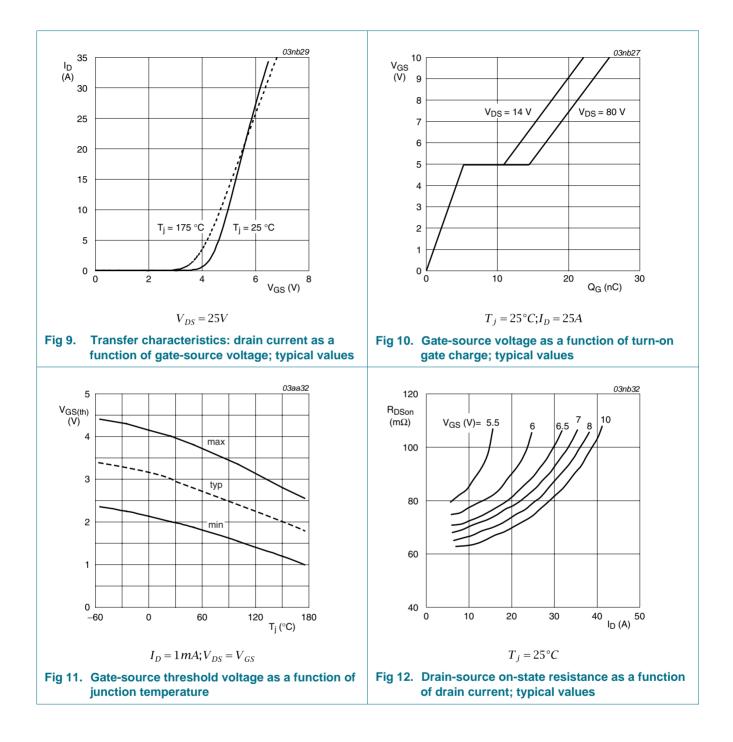
#### Nexperia

# BUK7675-100A



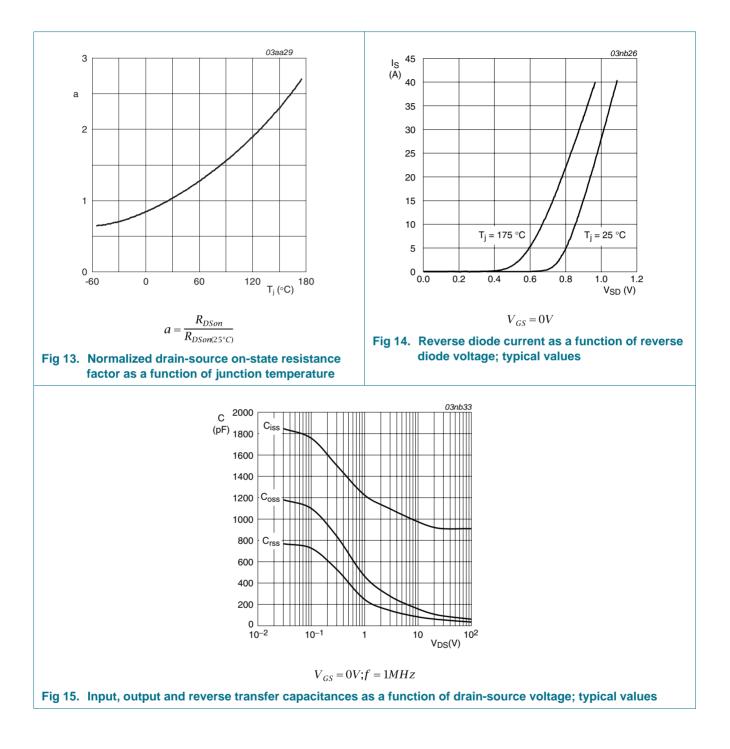
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# BUK7675-100A



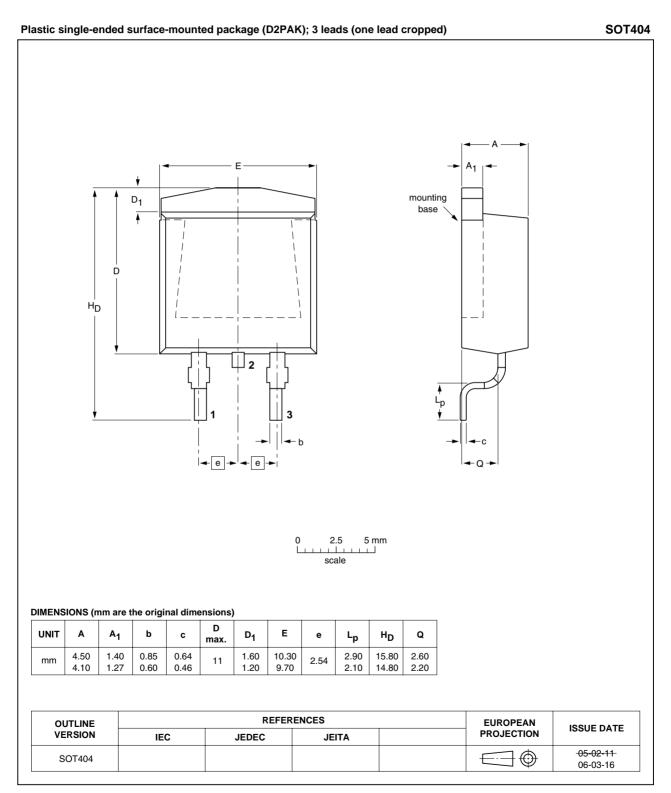
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# BUK7675-100A



#### N-channel TrenchMOS standard level FET

## 7. Package outline



#### Fig 16. Package outline SOT404 (D2PAK)

# 8. Revision history

Table 7. Revision histo	ory					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BUK7675-100A_2	20090731	Product data sheet	-	BUK7575_7675-100A-01		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>					
	<ul> <li>Legal texts</li> </ul>	have been adapted to the	new company name whe	re appropriate.		
	<ul> <li>Type number</li> </ul>	er BUK7675-100A separat	ed from data sheet BUK7	′575_7675-100A-01.		
BUK7575_7675-100A-01 (9397 750 07623)	20001024	Product specification	-	-		

# 9. Legal information

#### 9.1 Data sheet status

Document status [1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions"

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